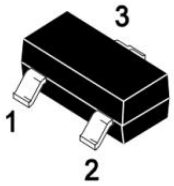
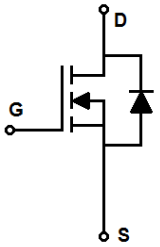
M06N03DJ

60V/3A N-Channel MOSFET

BVDSS	60	V
ID	3	A
RDSON@VGS=10V	78	mΩ
RDSON@VGS=4.5V	88	mΩ

SOT-23





1.Gate
2.Source
3.Drain

Features

- Advanced trench process technology
- High Density Cell Design For Ultra Low On-Resistance
- High Power and Current handing capability

Applications

- Low Side Load Switch
- Battery Switch
- Optimized for Power Management Applications for Portable Products, such as Aeromodelling, Power bank, Brushless motor, Main board , and Others

Order Information

Product	Package	Marking	Reel
M06N03DJ	SOT-23	CA2T	3000PCS

Absolute Maximum Ratings

Symbol	Parameter		Rating	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)				
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage		60	V
V_{GS}	Gate-Source Voltage		±20	V
T_J	Maximum Junction Temperature		150	°C
T_{STG}	Storage Temperature Range		-55 to 150	°C
I_S	Diode Continuous Forward Current	TA =25°C	3	A
Mounted on Large Heat Sink				
I_{DM}	Pulse Drain Current Tested (Sillicon Limit) (Note1)	TA =25°C	10	A
I_D	Continuous Drain current	TA =25°C	3	A
P_D	Maximum Power Dissipation	TA =25°C	1.38	W
$R_{\theta JA}$	Thermal Resistance Junction−to−Ambient (Note2)		90.5	°C/W

Note:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec

60V/3A N-Channel MOSFET

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
$V_{(BR)DSS}$	Drain- Source Breakdown Voltage	VGS=0V ID=250μA	60	--	--	V
I_{DSS}	Zero Gate Voltage Drain current	VDS=60V,VGS=0V	--	--	10	μA
I_{GSS}	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	VDS=VGS,ID=250μA	1	--	2	V
$R_{DS(ON)}$	Drain-Source On-State Resistance (Note3)	VGS=10V, ID=3A	--	78	90	mΩ
		VGS=4.5V, ID=2A	--	88	109	mΩ
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated) (Note4)						
C_{iss}	Input Capacitance	VDS= 25V, VGS=0V, F=1MHz	--	490	--	pF
C_{oss}	Output Capacitance		--	55	--	pF
C_{rss}	Reverse Transfer Capacitance		--	40	--	pF
Q_g	Total Gate Charge3	VDS= 30V, ID= 3A, VGS= 4.5V	--	6	--	nC
Q_{gs}	Gate-Source Charge		--	1.6	--	nC
Q_{gd}	Gate-Drain Charge		--	3	--	nC
Switching Characteristics (Note4)						
$t_{d(on)}$	Turn-on Delay Time	VDD=30V, ID=1A, RG=3.3Ω, VGS=10V	--	6	--	nS
t_r	Turn-on Rise Time		--	5	--	nS
$t_{d(off)}$	Turn-off Delay Time		--	16	--	nS
t_f	Turn-off Fall Time		--	3	--	nS
Source- Drain Diode Characteristics@ TJ = 25°C (unless otherwise stated)						
V_{SD}	Forward on voltage (Note3)	IS=1.2A,VGS=0V	--	--	1.2	V

Note:

3. Pulse Test: pulse width ≤ 300 us, duty cycle ≤ 2%.

4. Guaranteed by design, not subject to production testing.

60V/3A N-Channel MOSFET

Typical Characteristics

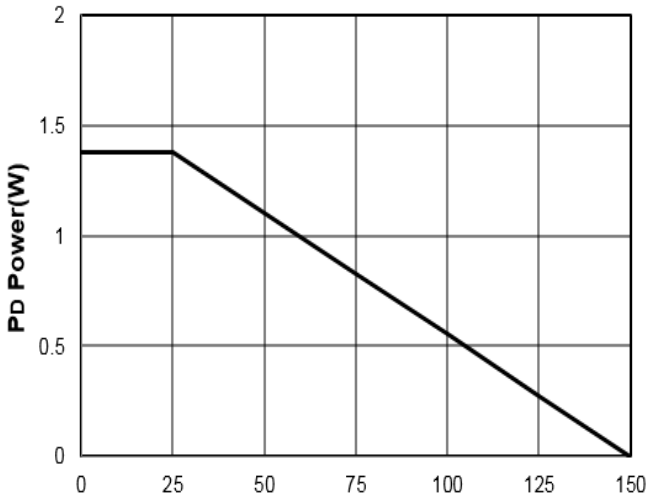


Figure1：T_J Junction Temperature（°C）

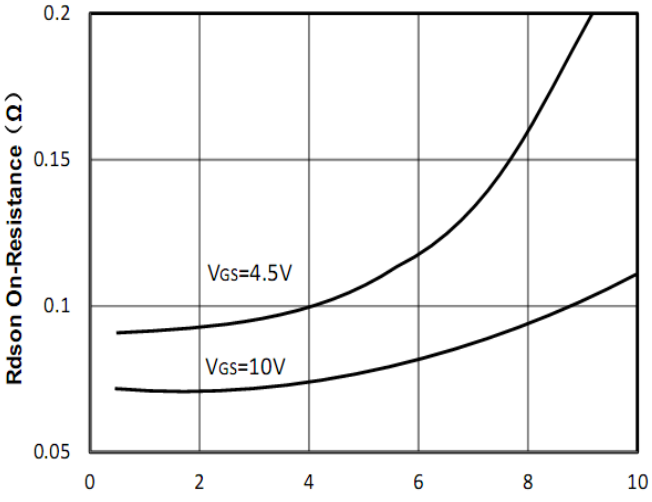


Figure2：I_D Drain Current（A）

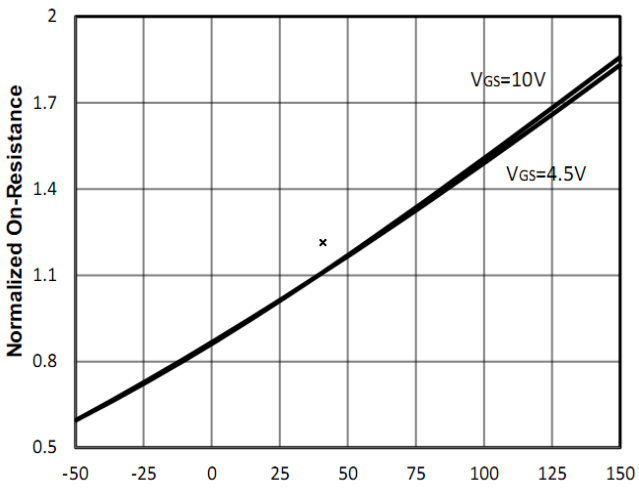


Figure3：T_J Junction Temperature（°C）

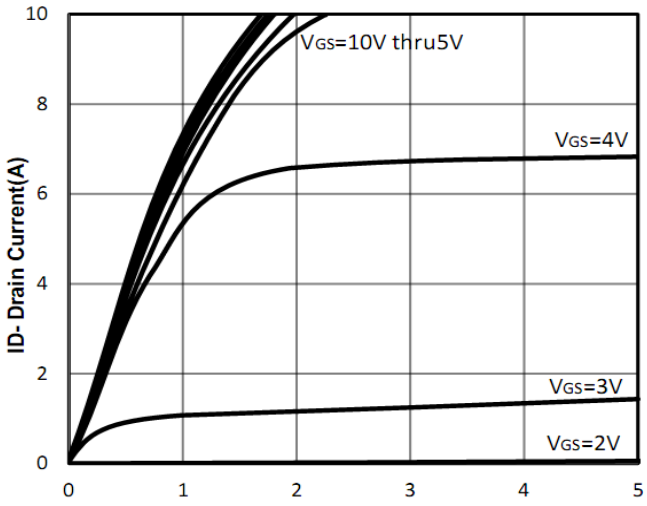


Figure4：V_{DS} Drain-Source Voltage（V）

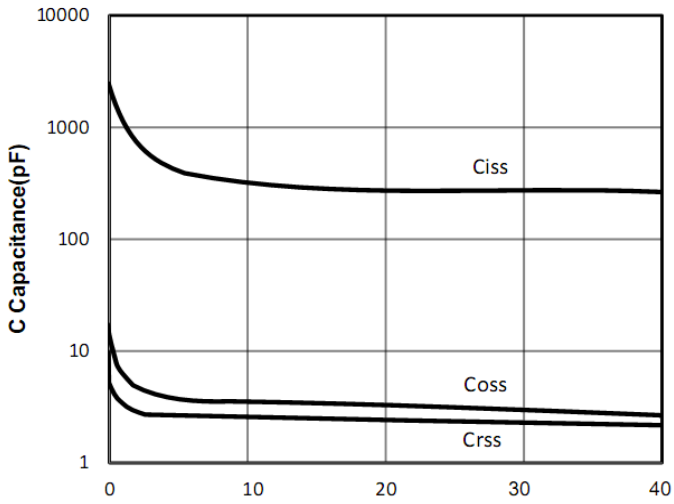


Figure5：V_{DS} Drain-Source Voltage（V）

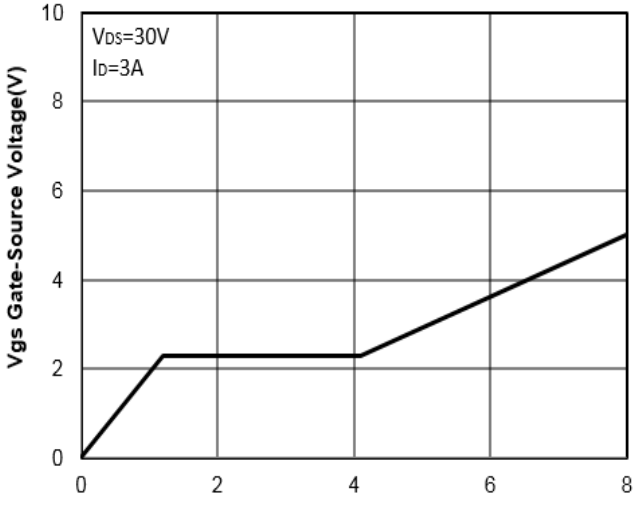


Figure6：Qg Gate Charge（nC）

60V/3A N-Channel MOSFET

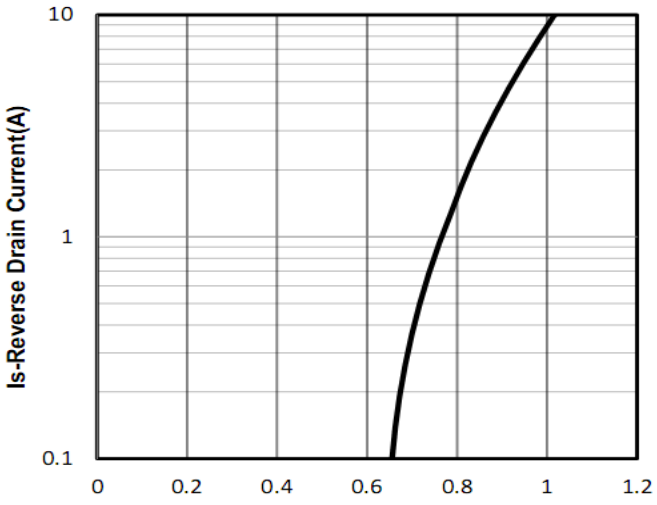


Figure7：Vsd Source-Drain Voltage（V）

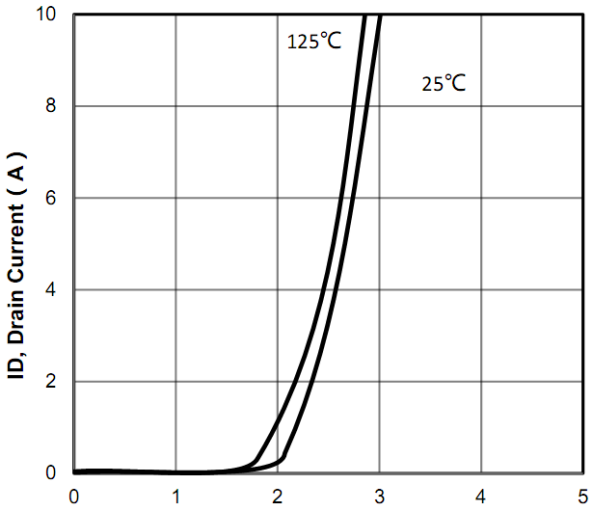


Figure8：Vgs Gate-Source Voltage（V）

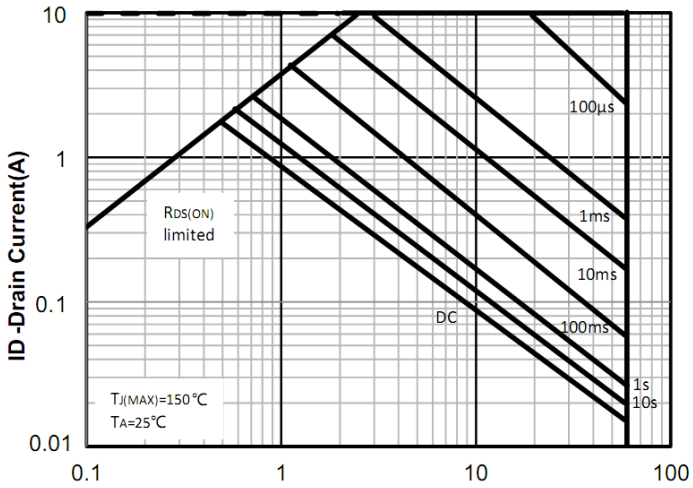


Figure9：Vds Drain -Source Voltage（V）

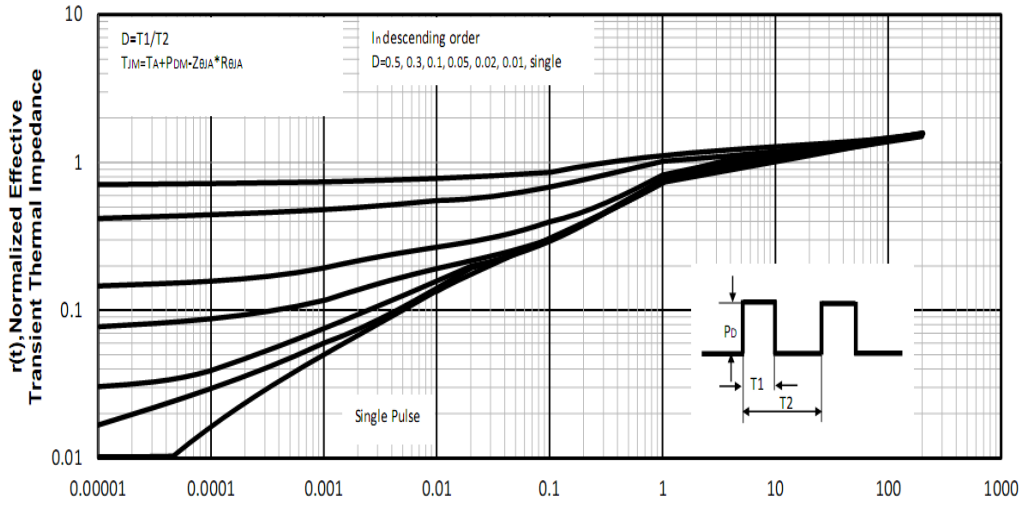


Figure10：Square Wave Pulse Duration（sec）

60V/3A N-Channel MOSFET

Test Circuit and Waveform:

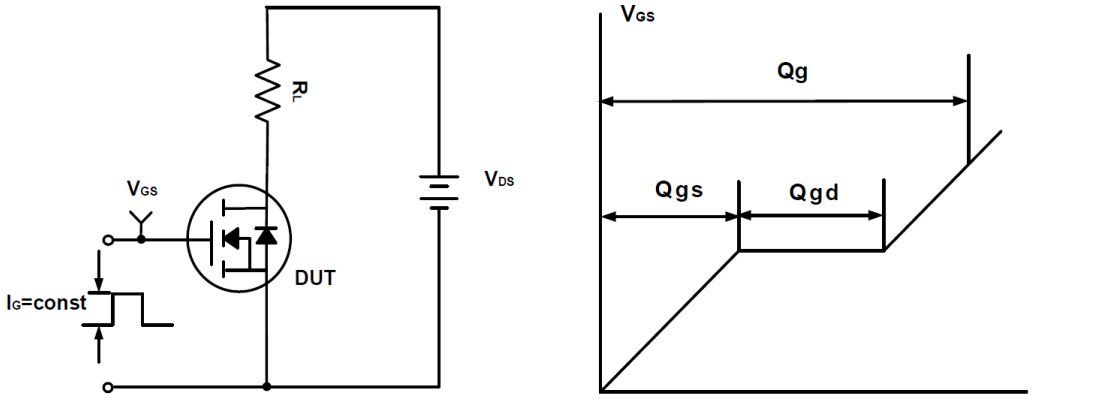


Figure A Gate Charge Test Circuit &Waveforms

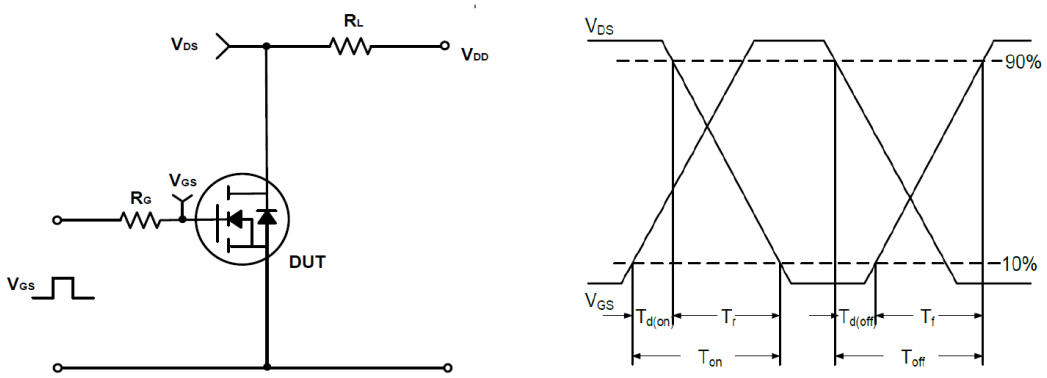


Figure B Switching Test Circuit & Waveforms

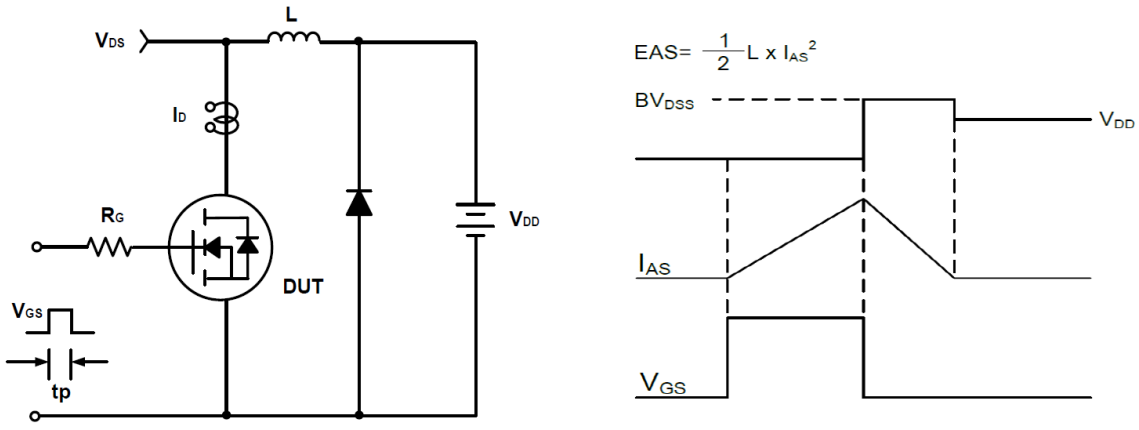
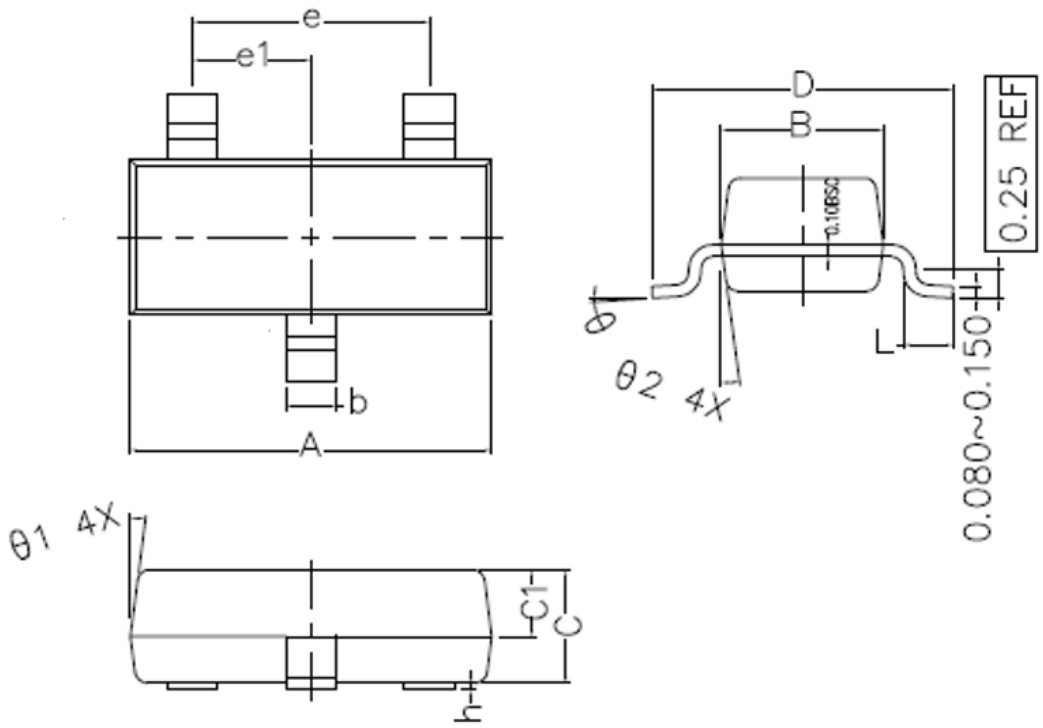


Figure C Unclamped Inductive Switching Circuit & Waveforms

60V/3A N-Channel MOSFET

SOT-23 Package Outline Dimensions (Units: mm)



COMMON DIMENSIONS (UNITS OF MEASURE IS mm)			
	MIN	NORMAL	MAX
A	2.800	2.900	3.000
B	1.200	1.300	1.400
C	0.900	1.000	1.100
C1	0.500	0.550	0.600
D	2.250	2.400	2.550
L	0.300	0.400	0.500
h	0.010	0.050	0.100
b	0.300	0.400	0.500
e	1.90 TYPE		
e1	0.95 TYPE		
θ_1	7° TYPE		
θ_2	7° TYPE		
θ	0° ~ 7°		